

To our customers,

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## Old Company Name in Catalogs and Other Documents

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On April 1<sup>st</sup>, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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EOL product

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## 2SC5812

Silicon NPN Epitaxial  
VHF/UHF wide band amplifier

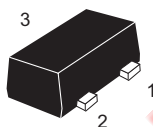
REJ03G0757-0100  
(Previous ADE-208-1468)  
Rev.1.00  
Aug.10.2005

### Application

- High power gain, Low noise figure at low power operation:  
 $|S_{21}|^2 = 17 \text{ dB typ}$ ,  $NF = 1.0 \text{ dB typ}$  ( $V_{CE} = 1 \text{ V}$ ,  $I_C = 5 \text{ mA}$ ,  $f = 900 \text{ MHz}$ )

### Outline

RENESAS Package code: PUSF0003ZA-A  
(Package name: MFPAK<sup>®</sup>)



1. Emitter
2. Base
3. Collector

Note: Marking is "WG-".

\*MFPAK is a trademark of Renesas Technology Corp.

### Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

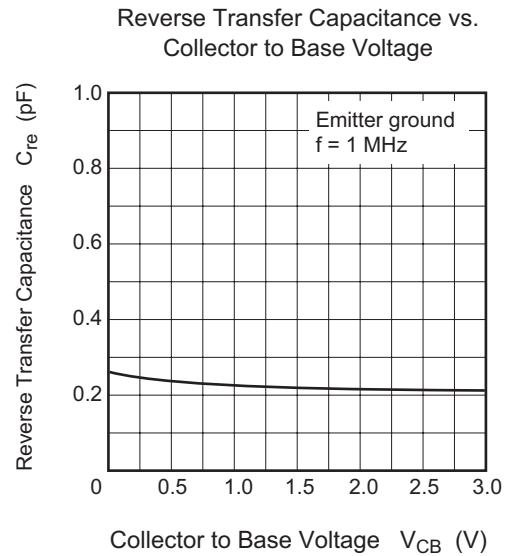
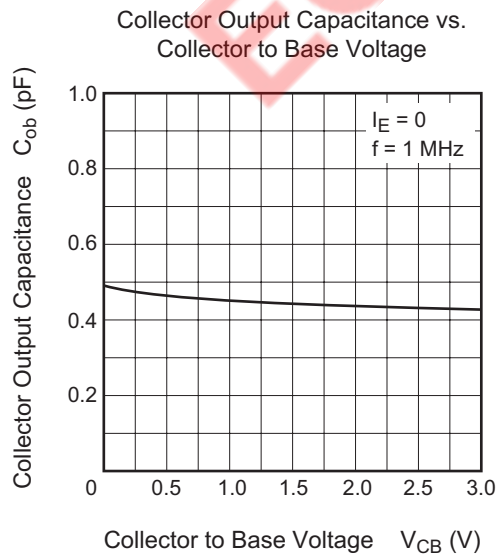
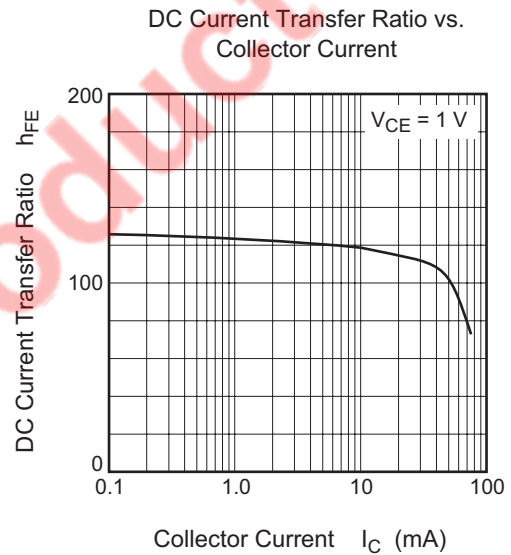
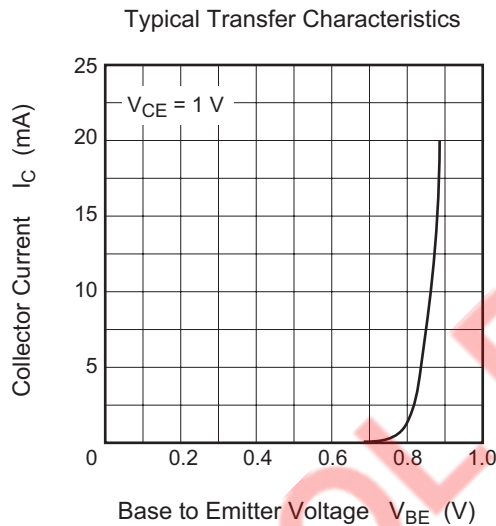
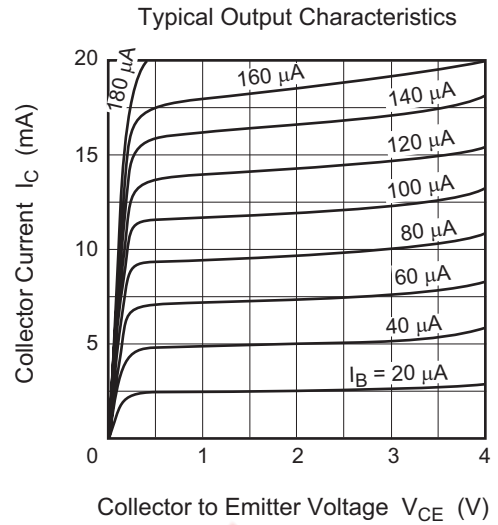
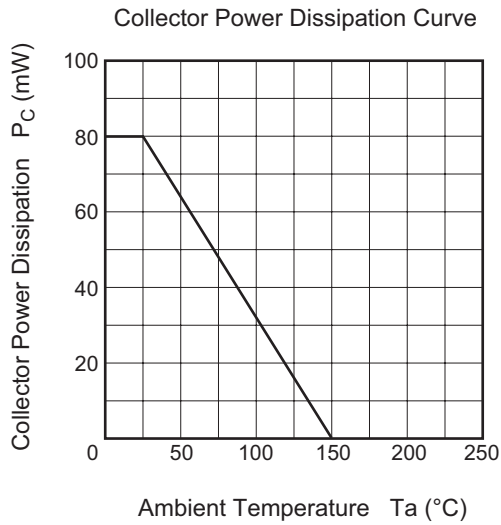
Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	15	V
Collector to emitter voltage	$V_{CEO}$	4	V
Emitter to base voltage	$V_{EBO}$	1.5	V
Collector current	$I_C$	50	mA
Collector power dissipation	$P_C$	80	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

## Electrical Characteristics

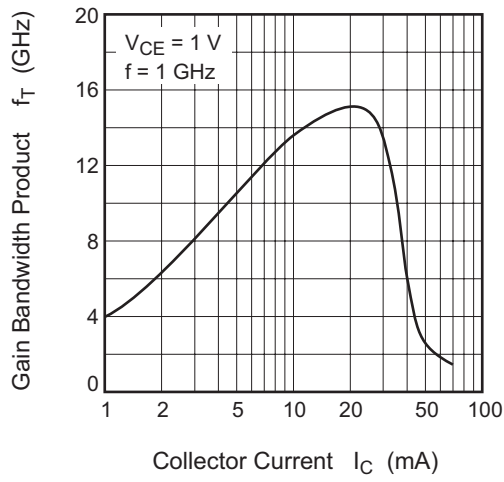
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	15	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector cutoff current	$I_{CBO}$	—	—	0.1	$\mu A$	$V_{CB} = 15 V, I_E = 0$
Collector cutoff current	$I_{CEO}$	—	—	1	$\mu A$	$V_{CE} = 4 V, R_{BE} = \infty$
Emitter cutoff current	$I_{EBO}$	—	—	0.1	$\mu A$	$V_{EB} = 0.8 V, I_C = 0$
DC current transfer ratio	$h_{FE}$	100	120	150		$V_{CE} = 1 V, I_C = 5 mA$
Reverse transfer capacitance	$C_{re}$	—	0.2	—	pF	$V_{CE} = 1 V$ , Emitter ground, $f = 1 MHz$
Collector output capacitance	$C_{ob}$	—	0.4	0.7	pF	$V_{CB} = 1 V, I_E = 0$ , $f = 1 MHz$
Gain bandwidth product	$f_T(1)$	8	11	—	GHz	$V_{CE} = 1 V, I_C = 5 mA$
Gain bandwidth product	$f_T(2)$	—	15	—	GHz	$V_{CE} = 1 V, I_C = 20 mA$
Forward transmission coefficient	$ S_{21} ^2$	14	17	—	dB	$V_{CE} = 1 V, I_C = 5 mA$ , $f = 900 MHz$
Noise figure	NF	—	1.0	1.7	dB	$V_{CE} = 1 V, I_C = 5 mA$ , $f = 900 MHz$ , $Z_S = Z_L = 50 \Omega$

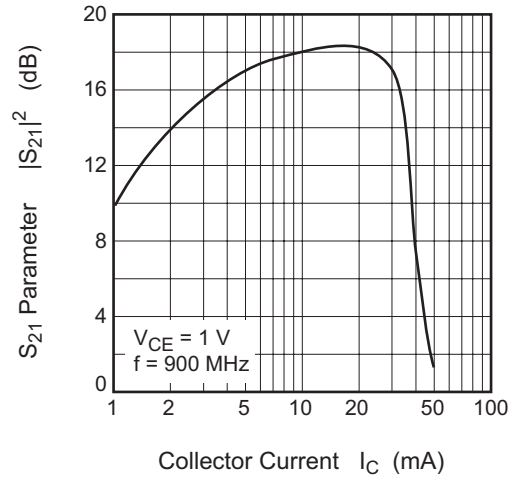
Main Characteristics



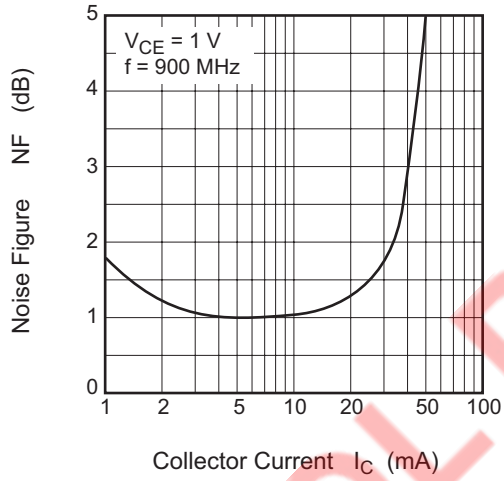
Gain Bandwidth Product vs. Collector Current



$S_{21}$  Parameter vs. Collector Current

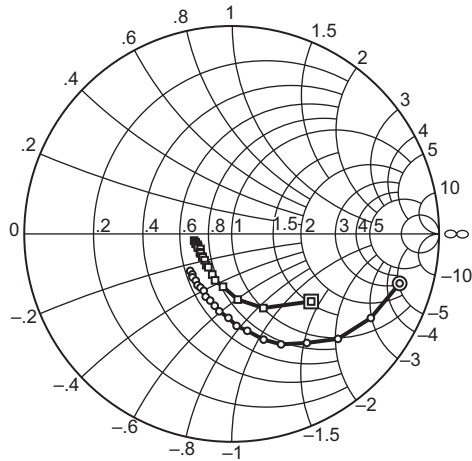


Noise Figure vs. Collector Current



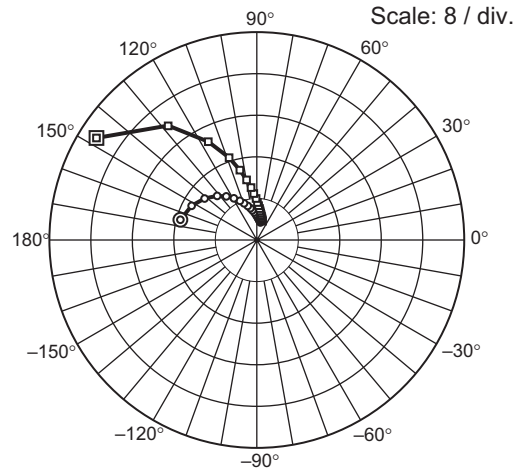
EOL Product

S<sub>11</sub> Parameter vs. Frequency



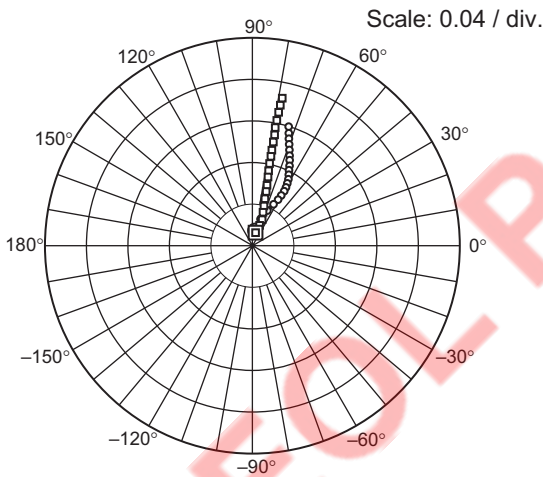
Test conditions:  $V_{CE} = 1\text{ V}$ ,  $Z_O = 50\ \Omega$   
 100 to 2000 MHz (100 MHz step)  
 ○—○ ( $I_C = 5\text{ mA}$ )  
 □—□ ( $I_C = 20\text{ mA}$ )

S<sub>21</sub> Parameter vs. Frequency



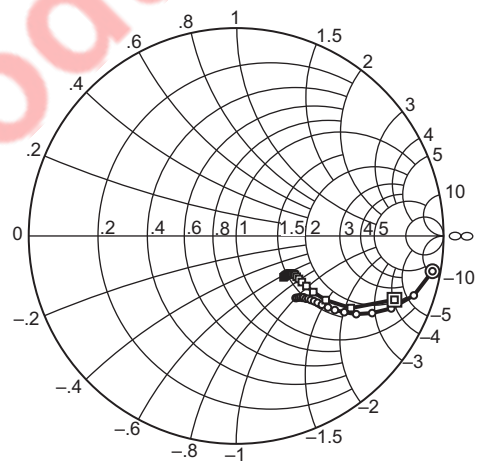
Test conditions:  $V_{CE} = 1\text{ V}$ ,  $Z_O = 50\ \Omega$   
 100 to 2000 MHz (100 MHz step)  
 ○—○ ( $I_C = 5\text{ mA}$ )  
 □—□ ( $I_C = 20\text{ mA}$ )

S<sub>12</sub> Parameter vs. Frequency



Test conditions:  $V_{CE} = 1\text{ V}$ ,  $Z_O = 50\ \Omega$   
 100 to 2000 MHz (100 MHz step)  
 ○—○ ( $I_C = 5\text{ mA}$ )  
 □—□ ( $I_C = 20\text{ mA}$ )

S<sub>22</sub> Parameter vs. Frequency



Test conditions:  $V_{CE} = 1\text{ V}$ ,  $Z_O = 50\ \Omega$   
 100 to 2000 MHz (100 MHz step)  
 ○—○ ( $I_C = 5\text{ mA}$ )  
 □—□ ( $I_C = 20\text{ mA}$ )

## S Parameter

 $(V_{CE} = 1 \text{ V}, I_C = 5 \text{ mA}, Z_O = 50 \Omega)$ 

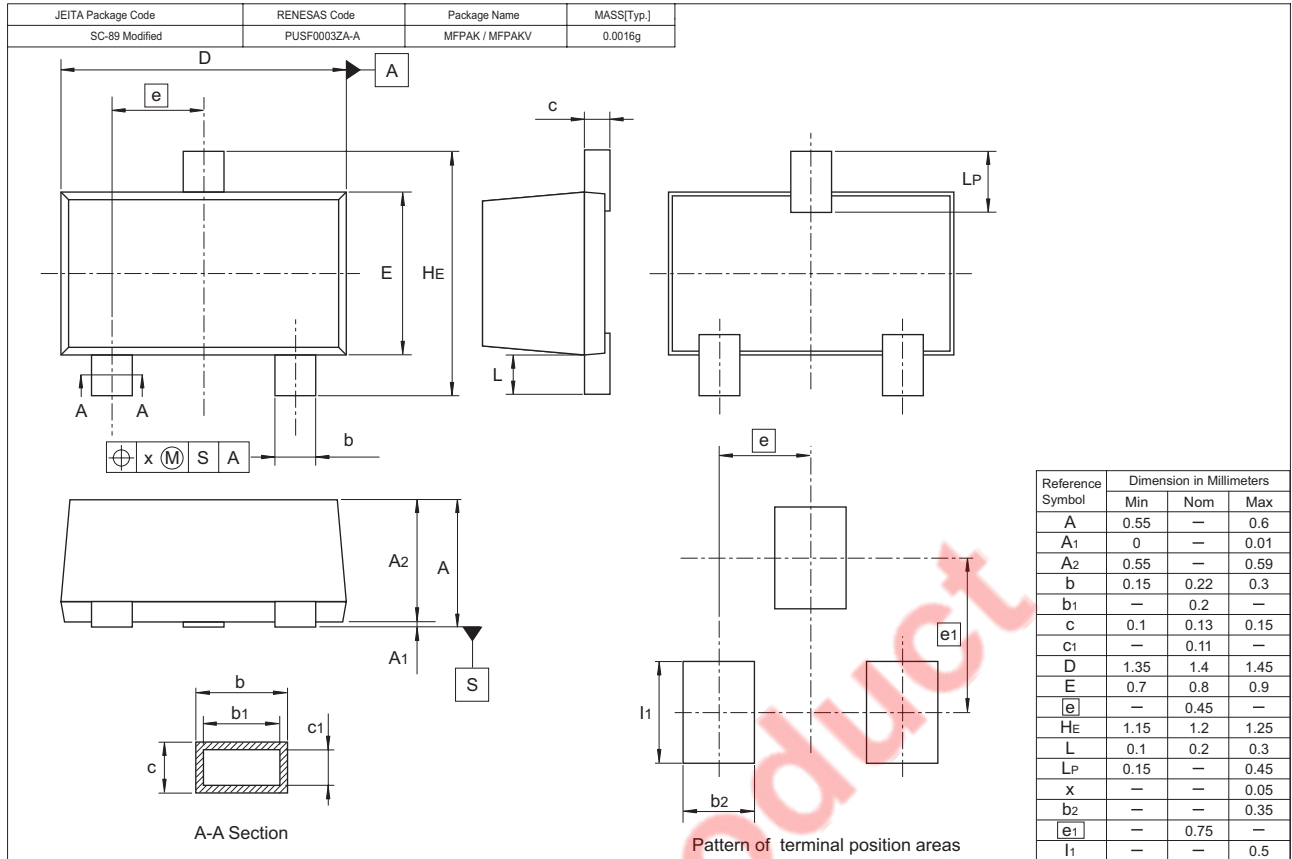
f (MHz)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
100	0.842	-16.3	15.23	164.9	0.015	80.2	0.963	-10.1
200	0.783	-31.7	14.17	152.2	0.027	72.9	0.904	-18.4
300	0.719	-44.6	12.84	141.4	0.037	66.8	0.826	-24.9
400	0.637	-55.4	11.41	131.8	0.045	62.9	0.754	-29.4
500	0.582	-65.9	10.25	124.8	0.051	60.8	0.691	-32.9
600	0.531	-73.2	9.16	118.6	0.056	60.1	0.638	-35.0
700	0.472	-80.9	8.22	113.1	0.061	59.7	0.595	-36.7
800	0.443	-87.0	7.49	108.9	0.065	60.0	0.561	-37.7
900	0.404	-92.3	6.80	104.6	0.069	60.7	0.530	-38.5
1000	0.377	-99.2	6.26	101.0	0.073	61.5	0.508	-39.1
1100	0.355	-103.4	5.80	98.1	0.077	62.8	0.490	-39.7
1200	0.337	-108.0	5.38	94.8	0.081	64.1	0.474	-40.4
1300	0.327	-112.6	5.04	92.4	0.085	65.0	0.461	-40.8
1400	0.305	-116.3	4.71	90.1	0.090	66.4	0.452	-41.7
1500	0.299	-120.3	4.45	87.7	0.094	67.5	0.440	-42.0
1600	0.297	-123.8	4.20	86.0	0.099	68.5	0.437	-42.8
1700	0.284	-127.7	3.98	83.6	0.104	70.0	0.428	-43.4
1800	0.282	-132.2	3.80	81.7	0.109	71.1	0.423	-44.3
1900	0.272	-134.3	3.62	79.8	0.114	72.0	0.418	-45.3
2000	0.268	-138.4	3.47	77.9	0.120	73.0	0.414	-46.0



(V<sub>CE</sub> = 1 V, I<sub>C</sub> = 20 mA, Z<sub>O</sub> = 50 Ω)

f (MHz)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
100	0.502	-40.3	36.64	147.5	0.013	76.3	0.824	-21.8
200	0.388	-66.7	27.85	127.8	0.021	70.3	0.653	-32.0
300	0.317	-84.6	21.13	116.2	0.027	69.3	0.531	-35.4
400	0.257	-99.2	16.75	108.5	0.034	72.2	0.460	-35.8
500	0.237	-109.6	13.87	103.5	0.040	73.6	0.416	-35.2
600	0.216	-115.5	11.77	99.5	0.047	75.0	0.387	-34.8
700	0.195	-125.0	10.19	96.1	0.054	75.6	0.367	-34.1
800	0.193	-129.2	9.00	93.5	0.060	76.3	0.352	-33.7
900	0.181	-135.9	8.03	90.8	0.068	77.1	0.340	-33.2
1000	0.179	-141.0	7.26	88.8	0.074	77.7	0.333	-33.3
1100	0.178	-142.4	6.66	86.8	0.081	78.1	0.326	-33.7
1200	0.176	-147.8	6.12	84.7	0.088	78.2	0.321	-34.0
1300	0.176	-150.0	5.68	83.2	0.094	78.4	0.317	-34.5
1400	0.166	-154.2	5.32	81.7	0.102	78.5	0.314	-35.1
1500	0.175	-158.0	4.97	80.0	0.109	78.6	0.311	-36.0
1600	0.172	-159.7	4.70	78.7	0.116	79.0	0.309	-36.8
1700	0.172	-162.4	4.43	77.0	0.123	78.9	0.307	-37.6
1800	0.179	-164.9	4.21	75.7	0.131	78.8	0.305	-38.6
1900	0.177	-166.8	4.01	74.3	0.138	78.7	0.304	-39.7
2000	0.183	-169.9	3.83	72.8	0.145	78.5	0.303	-40.8

### Package Dimensions



### Ordering Information

Part Name	Quantity	Shipping Container
2SC5812WG-TR-E	9000	φ 178 mm Reel, 8 mm Emboss Taping

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